



60V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D T _A = +25°C
601/	48mΩ @ V _{GS} = 10V	4.1A
60V	60mΩ @ V _{GS} = 4.5V	3.8A

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- DC-DC converters
- Power-management functions
- Backlighting

Features and Benefits

- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low Input Capacitance
- Low On-Resistance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMN6041SVTQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

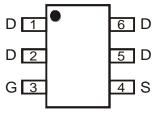
https://www.diodes.com/quality/product-definitions/

Mechanical Data

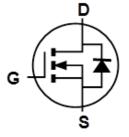
- Package: TSOT26
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Tin Finish Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (§3)
- Weight: 0.013 grams (Approximate)



Top View



Top View Pin Configuration



Equivalent Circuit

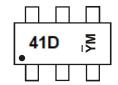
Ordering Information (Note 4)

Part Number	Pankaga	Packing		
Fait Nullibei	Package	Qty.	Carrier	
DMN6041SVTQ-7	TSOT26	3,000	Tape & Reel	
DMN6041SVTQ-13	TSOT26	10,000	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



41D = Product Type Marking Code $\overline{Y}M$ = Date Code Marking \overline{Y} = Year (ex: K = 2023) M = Month (ex: 9 = September)

Date Code Key

Year	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
Code	J	K	L	М	N	Р	R	S	T	U	V	W
8.0 4.0												
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	VDSS	60	V		
Gate-Source Voltage	V _{GSS}	±20	V		
Continuous Drain Current (Note 6) V _{GS} = 10V	ID	4.1 3.3	А		
Maximum Body Diode Forward Current (Note 6)	Is	4.1	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	IDM	20	Α		
Avalanche Current, L = 0.1mH	lar	16.2	Α		
Avalanche Energy, L = 0.1mH			Ear	13	mJ

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	0.9	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	138	°C/W
Total Power Dissipation (Note 6)		PD	1.7	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Reja	74	°C/W
Thermal Resistance, Junction to Case (Note 6)		R ₀ JC	13	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

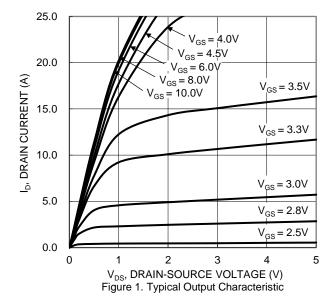
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

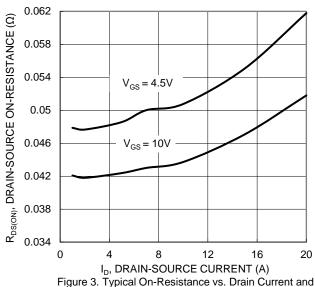
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Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BVDSS	60		_	V	$V_{GS} = 0V, I_{D} = 250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}			1	μA	$V_{DS} = 60V, V_{GS} = 0V$
Gate-Source Leakage	Igss			±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	1		3	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
Static Drain-Source On-Resistance	Descour		37	48	mΩ	$V_{GS} = 10V, I_{D} = 4.3A$
Static Drain-Source On-Resistance	RDS(ON)		43	60	11177	$V_{GS} = 4.5V, I_D = 4A$
Diode Forward Voltage	VsD		0.7	1.2	V	$V_{GS} = 0V$, $I_{S} = 1A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss		1190		pF	V _{DS} = 30V, V _{GS} = 0V f = 1.0MHz
Output Capacitance	Coss		51	_		
Reverse Transfer Capacitance	C _{RSS}		36			1 – 1.0101112
Gate Resistance	Rg		2.1	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1.0MHz$
Total Gate Charge (V _{GS} = 10V)	Q _G		21	_		
Total Gate Charge (V _{GS} = 4.5V)	Q _G	_	10	_	nC	Vps = 30V, lp = 4.3A
Gate-Source Charge	Qgs	_	2.7	_	IIC	VDS = 3UV, ID = 4.3A
Gate-Drain Charge	Q _{GD}	_	3.9	_		
Turn-On Delay Time	td(ON)	_	4.9	_		
Turn-On Rise Time	t _R	_	19	_		$V_{GS} = 10V$, $V_{DD} = 30V$, $R_{G} = 6\Omega$,
Turn-Off Delay Time	tD(OFF)	_	33	_	ns	$I_D = 4.3A$
Turn-Off Fall Time	tF	_	23	_		
Body Diode Reverse Recovery Time	t _{RR}	_	19	_	ns	$I_S = 4.3A$, $dI/dt = 100A/\mu s$
Body Diode Reverse Recovery Charge	Q _{RR}		13	_	nC	Is = 4.3A, dl/dt = 100A/µs

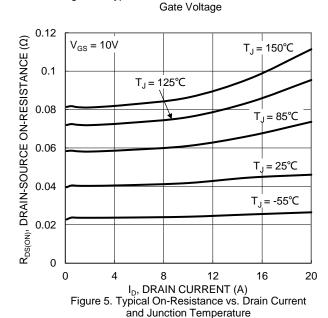
Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
7. Short duration pulse test used to minimize self-heating effect.
8. Guaranteed by design. Not subject to product testing.

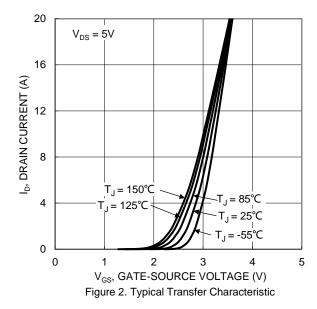


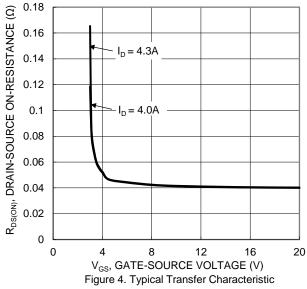












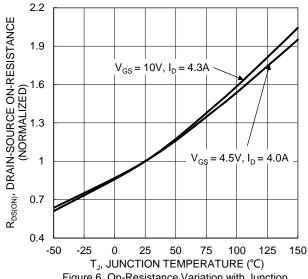


Figure 6. On-Resistance Variation with Junction Temperature





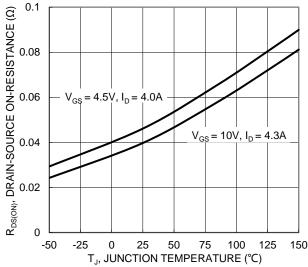
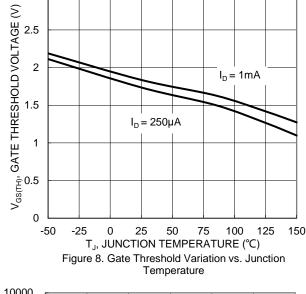
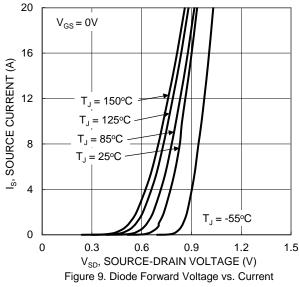
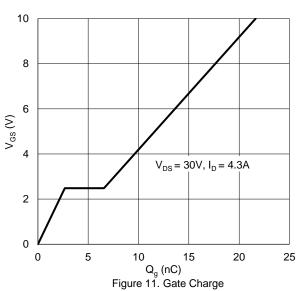


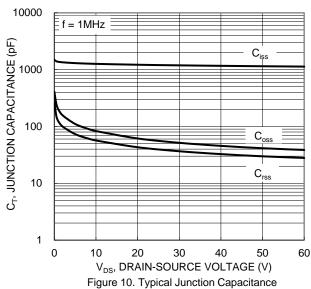
Figure 7. On-Resistance Variation with Junction Temperature

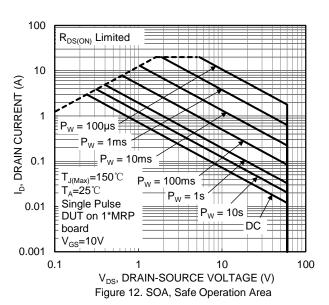


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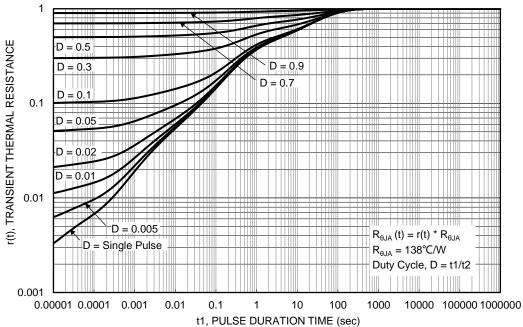


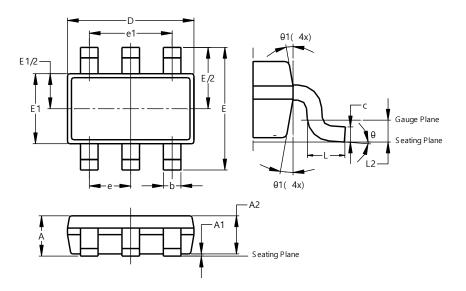
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

TSOT26

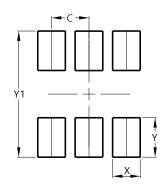


	TSOT26						
Dim	Min	Max	Тур				
Α	ı	1.00	-				
A1	0.010	0.100	_				
A2	0.840	0.900	-				
D	2.800	3.000	2.900				
Е	2	.800 BS	С				
E1	1.500	1.700	1.600				
b	0.300	0.450	-				
С	0.120	0.200	_				
е	0.950 BSC						
e1	1.900 BSC						
L	0.30	-					
L2	0	.250 BS	С				
θ	0°	8°	4°				
θ1	4°	12°	_				
Α	All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TSOT26



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
V1	3 200



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